



# Product Change Notification

## 109492 - 00

Information in this document is provided in connection with Intel products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

**Americas Contact:** [asmo.pcn@intel.com](mailto:asmo.pcn@intel.com)

**Asia Pacific Contact:** [apacgccb@intel.com](mailto:apacgccb@intel.com)

**Europe Email:** [eccb@intel.com](mailto:eccb@intel.com)

**Japan Email:** [jccb.ijkk@intel.com](mailto:jccb.ijkk@intel.com)

Copyright © Intel Corporation 2009. Other names and brands may be claimed as the property of others.

Celeron, Centrino, Intel, the Intel logo, Intel Core, Intel NetBurst, Intel NetMerge, Intel NetStructure, Intel SingleDriver, Intel SpeedStep, Intel StrataFlash, Intel Viiv, Intel XScale, Itanium, MMX, Paragon, PDCharm, Pentium, and Xeon are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

Learn how to use Intel Trade Marks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.



# Product Change Notification

**Change Notification #:** 109492 - 00  
**Change Title:** Intel® Chipsets, PCN 109492-00, Label, Country of Origin (COO) Label and Mark Changing from Malaysia to Costa Rica  
**Date of Publication:** August 3, 2009

## Key Characteristics of the Change:

Label

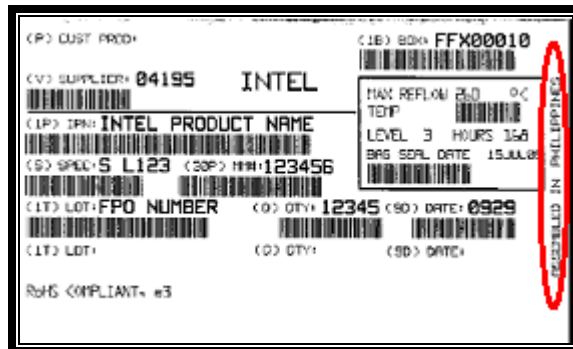
## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Oct 13, 2009
---	--------------

## Description of Change to the Customer:

In order to ensure a continuous supply of the Intel® Chipsets listed in the Products Affected Table below, these products will be transferring to another Intel qualified assembly site. The new site is located in Costa Rica. Due to this assembly site change, there will be two noticeable differences to the customer. First, the "Assembled In (Country)" on the Intermediate Box Label (I-box), see example below, will change from Malaysia to Costa Rica. Secondly, the Country of Origin (COO) identification marked on the product will also change from Malaysia to Costa Rica. All material and equipment will remain the same.

## Example: Intermediate Box Label (I-box) with COO identifier circled



## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers for this change. Customers may see products from either assembly site until current inventory is depleted. Customers may want to notify their receiving department of the change in Country of Origin marking.

**Products Affected / Intel Ordering Codes:**

<b>Pre Conversion Product Code</b>	<b>Pre Conversion S-Spec</b>	<b>Pre Conversion MM#</b>
QG5000X S L9TH	S L9TH	884923
NQ5000X S L9TG	S L9TG	884934
NQ5000Z S L9TJ	S L9TJ	884937
QG5000Z S L9TK	S L9TK	884939
NQ5000V S L9TL	S L9TL	884940
QG5000V S L9TM	S L9TM	884946
NQ5000P S L9TN	S L9TN	884950
QG5000P S L9TP	S L9TP	884951

**Reference Documents / Attachments:**

Document:

Location #:

**PCN Revision History:**

Date of Revision:

August 3, 2009

Revision Number:

00

Reason:

Originally Published PCN